

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	US-20070254986-\$ did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 12:26
L3	381259	curative hardener (cross adj2 linker) crosslinker ((curing hardening (cross adj2 linking) crosslinking) adj2 (agent promoter))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 12:55
L4	742437	epox\$6 diepox\$6 triepox\$6 polyepox\$6 glycidyl\$ diglycidyl\$ triglycidyl\$ tetraglycidyl\$ polyglycidyl\$	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 12:55
L5	280	L3.ab. and L4.ab. and pitch.ab.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 12:55
L6	7	L3.ab. and L4.ab. and (mesophase near5 pitch).ab.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 12:55
L7	8	L3.ab. and L4.ab. and pitch.ab. and (mesophase near5 pitch)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 12:57
L8	9	L3.ab. and L4.ab. and pitch and (mesophase near5 pitch)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 12:58
L9	96	(L3 same L4) and pitch and (mesophase near5 pitch)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 12:58
L10	29	(L3 same L4) and pitch and (mesophase near5 pitch) and (semiconductor (semi adj2 conductor))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 12:59

L11	39	(L3 and L4) and pitch and (mesophase near5 pitch) and (semiconductor (semi adj2 conductor))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 13:04
L12	41	(L3 and L4) and pitch and (mesophase near5 pitch) and (semiconductor (semi adj2 conductor) ((sealing encapsulat \$5) near5 electronic))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 13:08
L13	2	l12 not l11	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 13:09
L14	2683	(L3 and L4) and pitch and (semiconductor (semi adj2 conductor) ((sealing encapsulat \$5) near5 electronic))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 13:10
L15	1767	((L3 same L4) (l3.ab. and l4. ab.) and pitch and (semiconductor (semi adj2 conductor) ((sealing encapsulat \$5) near5 electronic))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 13:11
L16	32	((L3 same L4) (l3.ab. and l4. ab.) and (pitch same mesophase) and (semiconductor (semi adj2 conductor) ((sealing encapsulat \$5) near5 electronic))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 13:11
L17	122	((L3 same L4) (l3.ab. and l4. ab.) and (pitch with carbon) and (semiconductor (semi adj2 conductor) ((sealing encapsulat \$5) near5 electronic))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 13:13
L18	1	"mcmb green"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 13:32
L19	2	jp-2001114986-\$ did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 13:34
L20	1	2001-484833.NRAN.	DERWENT	OR	OFF	2009/06/18 13:34

L21	26	{"("6528559").pn. kr-20010074819-\$ did. jp-60119760-\$ did. jp-63179921-\$ did. jp-11060904-\$ did. jp-2003160713-\$ did. jp-2004256687-\$ did. jp-09077846-\$ did. jp-06184131-\$ did. jp-05287052-\$ did. jp-2003327792-\$ did. jp-62227955-\$ did. jp-10259292-\$ did. jp-2001335620-\$ did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 13:50
L22	3	l21 and pitch	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 14:07
L23	6	jp-2004256687-\$ did. jp-09077846-\$ did. jp-06184131-\$ did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 14:09
L24	3451	L3 and pitch and (semiconductor (semi adj2 conductor) ((sealing encapsulat \$5) near5 electronic))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 14:12
L25	3451	L3 and (pitch mesopitch) and (semiconductor (semi adj2 conductor) ((sealing encapsulat \$5) near5 electronic))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 14:12
L26	1615273	(L3 thermoset thermosetting). ab. (pitch mesopitch).ab. (semiconductor (semi adj2 conductor) ((sealing encapsulat \$5) near5 electronic)).ab.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 14:13
L27	1003	l25 and l26	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 14:13
L28	1531907	(L3).ab. (pitch mesopitch).ab. (semiconductor (semi adj2 conductor) ((sealing encapsulat \$5) near5 electronic)).ab.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 14:13
L29	956	l25 and l28	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 14:13

L30	8	I29 and (mesophase (meso adj2 phase))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 14:14
L31	3	I29 and (pitch with resistivity)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 14:16
L32	97	I29 and (resistivity)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 14:17
L33	323	(mesophase (meso adj2 phase)) with pitch with (sphere microsphere spherical microspherical)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 14:41
L34	38	I3 and I4 and I33	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 14:41
L35	15	I21 and I3 and I4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 14:54
L36	14	I35 and (semiconductor (semi adj2 conductor) ((sealing encapsulat\$5) near5 electronic))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 14:55
L37	23	I21 and I4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 14:56
L38	22	I37 and (semiconductor (semi adj2 conductor) ((sealing encapsulat\$5) near5 electronic))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 14:56
L39	283	phosphazene near5 (crosslink \$3 (cross adj2 link\$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 15:18

L40	0	l1.ab. and (phenol phenolic l3). ab. and l39.ab.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 15:19
L41	24	l4.ab. and (phenol phenolic l3). ab. and l39.ab.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 15:19
L42	118	tendou-k\$.in. tendou-k\$-.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 15:30
L43	485	katayose-m\$.in. katayose-m\$-.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 15:30
L44	67	l42 and l43	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 15:30
L45	927526	l42 l43 hitachi.as.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 15:30
L46	18	l45 and l4.clm. and pitch.clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 15:31
L47	661	523/440.ccls. 523/468.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 15:33
L48	5821	257/787.ccls. 257/788.ccls. 257/789.ccls. 257/793.ccls. 257/795.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 15:34
L49	103	(l47 l48) and l4 and l3 and pitch	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 15:34

L50	2	(I47 I48) and I4 and I3 and pitch and (mesophase (meso adj2 phase))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/06/18 15:34
S25	496814	silicone polysiloxane polyorganosiloxane polydiorganosiloxane organopolysiloxane organosiloxane diorganopolysiloxane siloxane organosilicone	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/14 09:00
S26	317795	curative hardener (cross adj2 linker) crosslinker ((curing hardening (cross adj2 linking) crosslinking) adj2 (agent promoter))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/06/28 14:33
S27	1222941	amine amino diamine diamino triamine triamino polyamine polyamino	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/12/12 13:13
S28	605176	epox\$6 diepox\$6 triepox\$6 polyepox\$6 glycidyl\$ diglycidyl\$ triglycidyl\$ tetraglycidyl\$ polyglycidyl\$	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/14 09:01

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